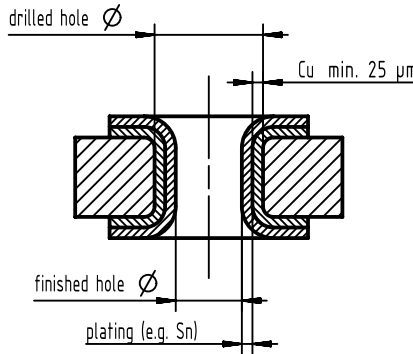
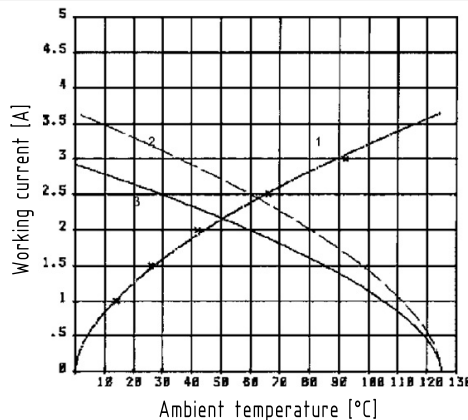
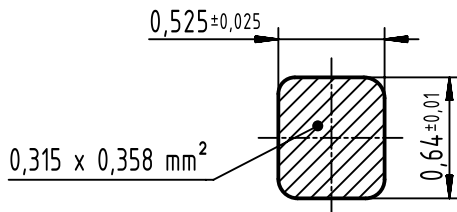


1	2	3	4	5	6	7	8																																															
 SEK 18 male low profile solder and press-in  RoHS compliant				Recommended configuration of plated through holes for press-in termination In addition to the hot-air-level (HAL), other PCB surfaces are getting more important. Due to their different properties – such as mechanical strength and coefficient of friction – we recommend the following configuration of PCB through holes.  <table><tr><td rowspan="3">Tin plated PCB (HAL) acc. to EN 60352-5</td><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td>Sn</td><td>max. 15 µm</td></tr><tr><td rowspan="3">Chemical tin plated PCB</td><td>plated hole Ø</td><td>0,94 – 1,09 mm</td></tr><tr><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td rowspan="2"></td><td>Sn</td><td>min. 0,8µm</td></tr><tr><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr><tr><td rowspan="4">Gold /Nickel plated PCB</td><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td>Ni</td><td>3 – 7 µm</td></tr><tr><td>Au</td><td>0,05 – 0,12 µm</td></tr><tr><td rowspan="3"></td><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr><tr><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td rowspan="2"></td><td>Ag</td><td>0,1 – 0,3 µm</td></tr><tr><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr><tr><td rowspan="3">Copper plated PCB (OSP)</td><td>Drilled hole Ø</td><td>1,15-0,03 mm</td></tr><tr><td>Cu</td><td>min. 25 µm</td></tr><tr><td>plated hole Ø</td><td>1,00 – 1,10 mm</td></tr></table>				Tin plated PCB (HAL) acc. to EN 60352-5	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm	Sn	max. 15 µm	Chemical tin plated PCB	plated hole Ø	0,94 – 1,09 mm	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm		Sn	min. 0,8µm	plated hole Ø	1,00 – 1,10 mm	Gold /Nickel plated PCB	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm	Ni	3 – 7 µm	Au	0,05 – 0,12 µm		plated hole Ø	1,00 – 1,10 mm	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm		Ag	0,1 – 0,3 µm	plated hole Ø	1,00 – 1,10 mm	Copper plated PCB (OSP)	Drilled hole Ø	1,15-0,03 mm	Cu	min. 25 µm	plated hole Ø	1,00 – 1,10 mm
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Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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